# Victoria Moran

|                                                                                                            | vmoran@hmc.edu   (858)2                                                                        | 04-0327   11947 Dapple Way, San Diego, CA 92128                                                                             |  |
|------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------|--|
|                                                                                                            |                                                                                                | vickimoran.github.io                                                                                                        |  |
|                                                                                                            |                                                                                                | - EDUCATION -                                                                                                               |  |
| Harvey Mudd                                                                                                | College – Claremont, CA                                                                        | Expected May 2020                                                                                                           |  |
| Bachelor of Science in Engineering                                                                         |                                                                                                | GPA: 3.81/4.00                                                                                                              |  |
|                                                                                                            | ean's List (all semesters)                                                                     | Major GPA: 3.89/4.00                                                                                                        |  |
| _                                                                                                          | -                                                                                              | ics   Electronic and Magnetic Devices and Circuits   Control Systems  <br>computer Engineering   Experimental Engineering   |  |
|                                                                                                            | •                                                                                              | ineering   Intro to Engineering Design and Manufacturing  <br>omagnetic Theory and Optics   Multivariable Calculus          |  |
|                                                                                                            |                                                                                                | SKILLS —                                                                                                                    |  |
| EE                                                                                                         | Circuit Design   PCB Layout (Altium) and Verification   Embedded Systems   FPGA   Raspberry Pi |                                                                                                                             |  |
| Programming Matlab   C++   C   SystemVerilog   Java   Python   Linux   Git   R   Arduino   Verilog-A   HSF |                                                                                                | g   Java   Python   Linux   Git   R   Arduino   Verilog-A   HSPICE                                                          |  |
| Languages English   Mandarin (Intermediate)   Spanish (Beginner)                                           |                                                                                                |                                                                                                                             |  |
| Other                                                                                                      | CAD (SolidWorks)   Machining   Modeling   Rapid Prototyping   Innovation (patent pending)      |                                                                                                                             |  |
|                                                                                                            |                                                                                                | ng   New Product Development   Lab Equipment                                                                                |  |
|                                                                                                            | INI                                                                                            | OUSTRY EXPERIENCE —                                                                                                         |  |
| <b>Square</b>   Elect                                                                                      | rical Engineering Intern                                                                       | June - August 2019                                                                                                          |  |
|                                                                                                            |                                                                                                | nents board to ensure functionality and signal integrity                                                                    |  |
| _                                                                                                          | _                                                                                              | ging through schematic capture and PCB layout of debug interfaces using a new connector and modified schematics accordingly |  |
| <b>HP</b>   R&D Systems Engineer Intern                                                                    |                                                                                                | May - August 2018                                                                                                           |  |
|                                                                                                            |                                                                                                | ne of curing various inks on textiles from 3 minutes to <1 second                                                           |  |
| <ul> <li>Collabor</li> </ul>                                                                               | ated with an international team to mo                                                          | et product development timelines and protect intellectual property                                                          |  |
| _                                                                                                          | <b>eges</b>   Sustainability Intern<br>d emissions data to create a baseline g                 | City of Rancho Cucamonga   January 2018 - May 2018 reenhouse gas inventory for Rancho Cucamonga Municipal Operations        |  |
|                                                                                                            | RES                                                                                            | EARCH EXPERIENCE ———————————————————————————————————                                                                        |  |
|                                                                                                            | t Engineering Lab   Undergraduate and simulate phase change memory are                         | Researcher HMC   January 2018 - present ays to determine how selector diode quality limits array size                       |  |
|                                                                                                            | rity Lab   Undergraduate Researcher<br>ed a public key exchange protocol to                    | University of Nebraska-Lincoln   June - August 2017<br>manage and distribute keys on the Interplanetary Overlay Network     |  |
|                                                                                                            |                                                                                                | — PROJECTS —                                                                                                                |  |
| Tovota Motor                                                                                               | Fuel Cell Clinic                                                                               | HMC   Fall 2018                                                                                                             |  |

## Toyota Motor Fuel Cell Clinic

HMC | Fall 2018

Optimized power configuration of fuel cell stack and battery for chosen mid-sized North American vehicles

## MIDI Pattern Visualizer

HMC | Fall 2018

- Implemented a system that plays and displays a sequence of notes recorded from a MIDI keyboard
- Raspberry Pi sends notes over SPI to FPGA which stores the pattern in shift registers and interfaces to an LED matrix

# Autonomous Underwater Vehicle

HMC | Spring 2018

Built a robot that navigates underwater using acoustic control to follow a beacon and measure properties of the water

## Vehicular Child Safety Device

HMC | Fall 2017

Developed a notification system using sensors in a car seat and a driver's seat to alert parents who leave children in cars

## **ACTIVITIES**

Digital Electronics Lab Proctor - Assist students with labs to ensure concept understanding

HMC | Aug 2018 - present

Machine Shop Proctor - Supervise and guide students with machine use

HMC | Jan 2018 - present

Wellness Peer - Organize events to promote seven dimensions of wellness

HMC | Aug 2017 - present

**Dorm Mentor** - Serve as peer advisor for first-year students

HMC Division of Student Affairs | Aug 2017 - Dec 2018